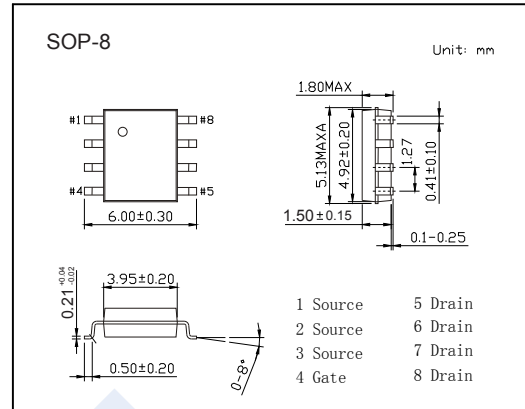
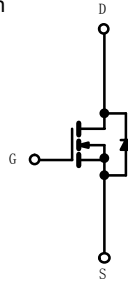


## N-Channel MOSFET

### SI4490DY-HF (KI4490DY-HF)

#### ■ Features

- $V_{DS} (V) = 200V$
- $I_D = 4A (V_{GS} = 10V)$
- $R_{DS(ON)} < 80m\Omega (V_{GS} = 10V)$
- $R_{DS(ON)} < 90m\Omega (V_{GS} = 6V)$
- Pb-Free Package May be Available. The G-Suffix Denotes a Pb-Free Lead Finish



#### ■ Absolute Maximum Ratings $T_a = 25^\circ C$

Parameter	Symbol	10S	Steady State	Unit	
Drain-Source Voltage	$V_{DS}$	200		V	
Gate-Source Voltage	$V_{GS}$	$\pm 20$		V	
Continuous Drain Current ( $T_J=150^\circ C$ ) *1	$I_D$	$T_A=25^\circ C$	4	2.85	A
		$T_A=70^\circ C$	3.2	2.3	
Pulsed Drain Current	$I_{DM}$	40		A	
Avalanch Current	$I_{AS}$	15		A	
Power Dissipation *1	$P_D$	$T_A=25^\circ C$	3.1	1.56	W
		$T_A=70^\circ C$	2	1	
Thermal Resistance.Junction- to-Ambient *1	$R_{thJA}$	40	80	$^\circ C/W$	
Thermal Resistance.Junction- to-Foot	$R_{thJF}$		21		
Junction Temperature	$T_J$	150		$^\circ C$	
Storage Temperature Range	$T_{stg}$	-55 to 150			

\*1: Surface Mounted on 1" x 1" FR4 board.

#### ■ Marking

Marking	4490 KC**** F
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## N-Channel MOSFET

### SI4490DY-HF (KI4490DY-HF)

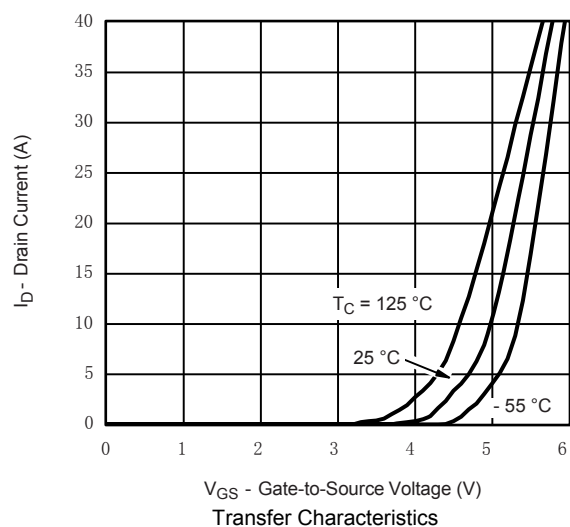
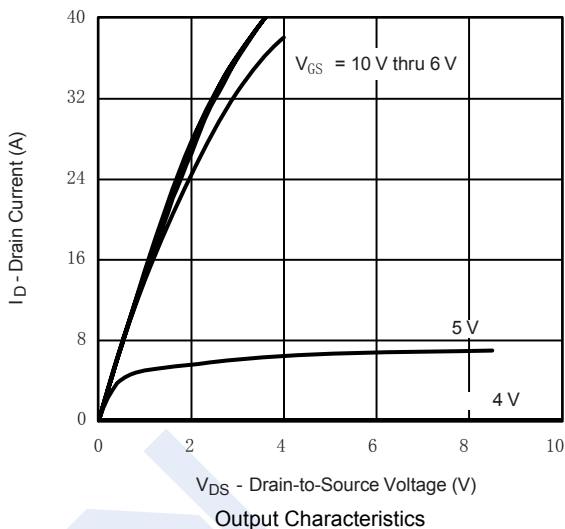
#### ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =250 μA, V <sub>GS</sub> =0V	200			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =160V, V <sub>GS</sub> =0V			1	μA
		V <sub>DS</sub> =160V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			5	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μA	2			V
Static Drain-Source On-Resistance *1	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4A			80	mΩ
		V <sub>GS</sub> =6V, I <sub>D</sub> =4A			90	
On State Drain Current	I <sub>D(ON)</sub>	V <sub>GS</sub> = 10 V, V <sub>DS</sub> ≥ 5V	40			A
Forward Transconductance *1	g <sub>FS</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =5A		19		S
Gate Resistance *2	R <sub>g</sub>		0.2	0.85	1.3	Ω
Total Gate Charge	Q <sub>g</sub>			34	42	nC
Gate Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =100V, I <sub>D</sub> =4A *2		7.5		
Gate Drain Charge	Q <sub>gd</sub>			12		
Turn-On DelayTime	t <sub>d(on)</sub>			14	20	ns
Turn-On Rise Time	t <sub>r</sub>	V <sub>GS</sub> =10V, V <sub>DS</sub> =100V, R <sub>L</sub> =25 Ω,		20	30	
Turn-Off DelayTime	t <sub>d(off)</sub>	R <sub>G</sub> =6 Ω, I <sub>D</sub> =4A *2		32	50	
Turn-Off Fall Time	t <sub>f</sub>			25	35	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2.8A, di/dt= 100A/μs		70	100	
Maximum Body-Diode Continuous Current	I <sub>S</sub>				2.8	A
Diode Forward Voltage *1	V <sub>SD</sub>	I <sub>S</sub> =2.8A, V <sub>GS</sub> =0V		0.75	1.2	V

\*1: Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.

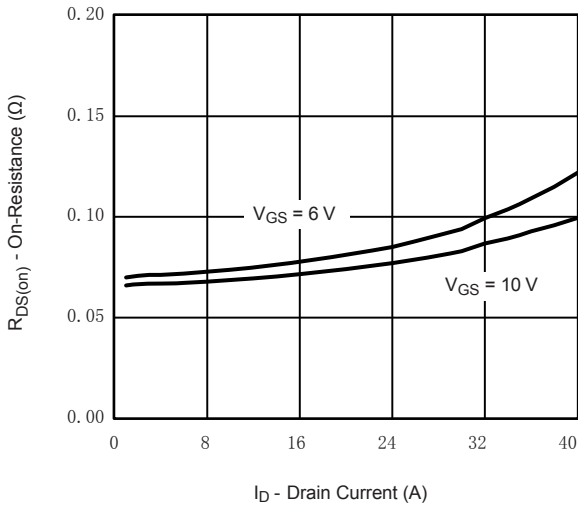
\*2: Guaranteed by design, not subject to production testing.

#### ■ Typical Characteristics

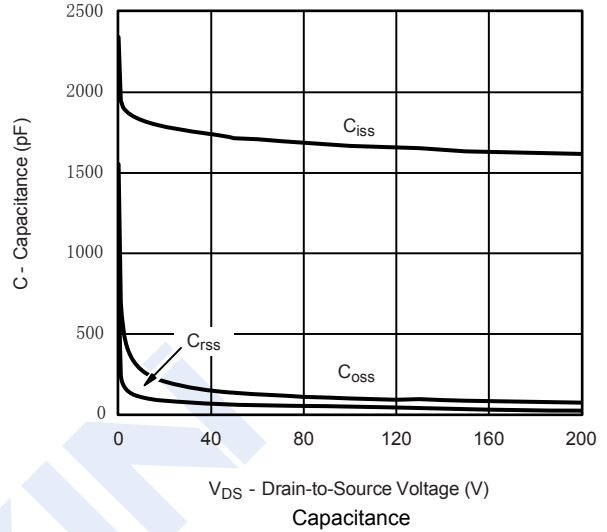


## N-Channel MOSFET SI4490DY-HF (KI4490DY-HF)

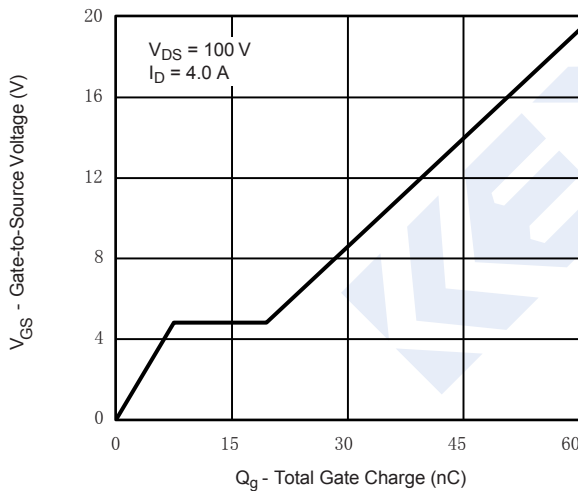
■ Typical Characteristics



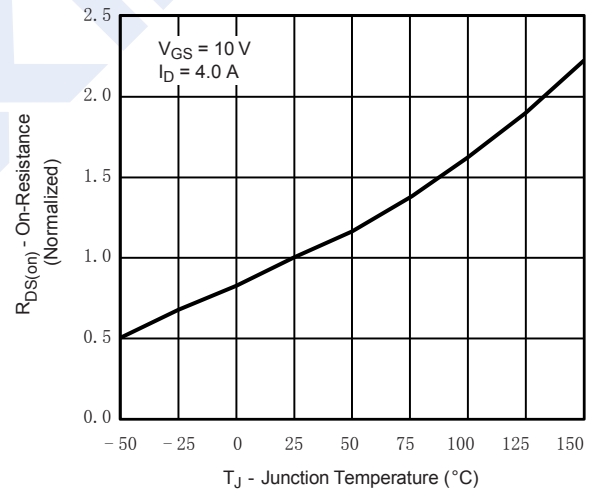
On-Resistance vs. Drain Current



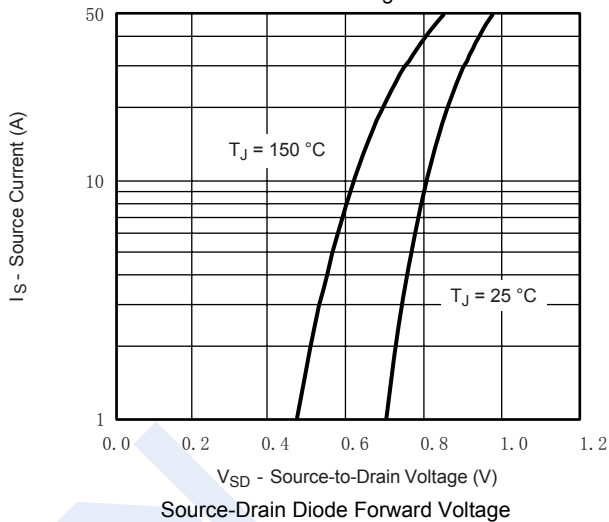
Capacitance



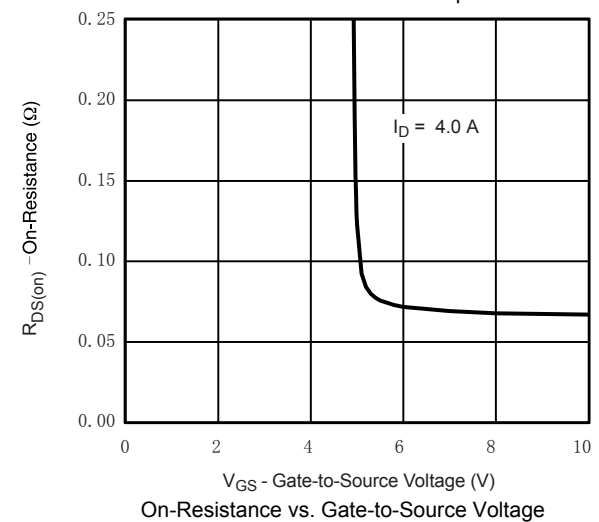
Gate Charge



On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

## N-Channel MOSFET SI4490DY-HF (KI4490DY-HF)

■ Typical Characteristics

